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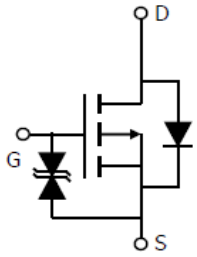
/ Equivalent Circuit



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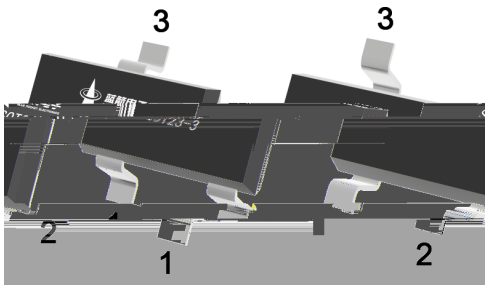

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/ Electrical Characteristic Curve

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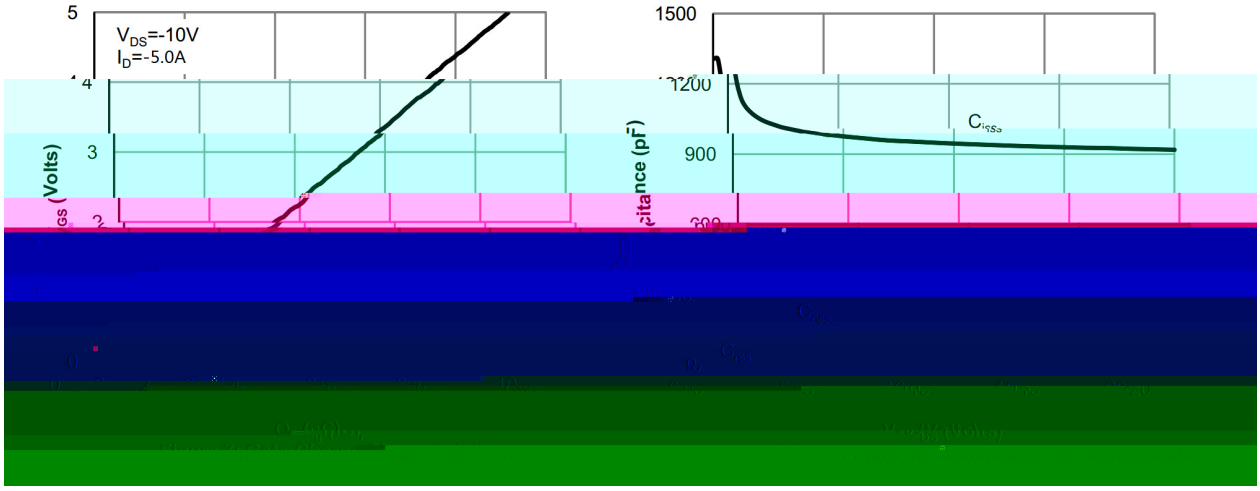
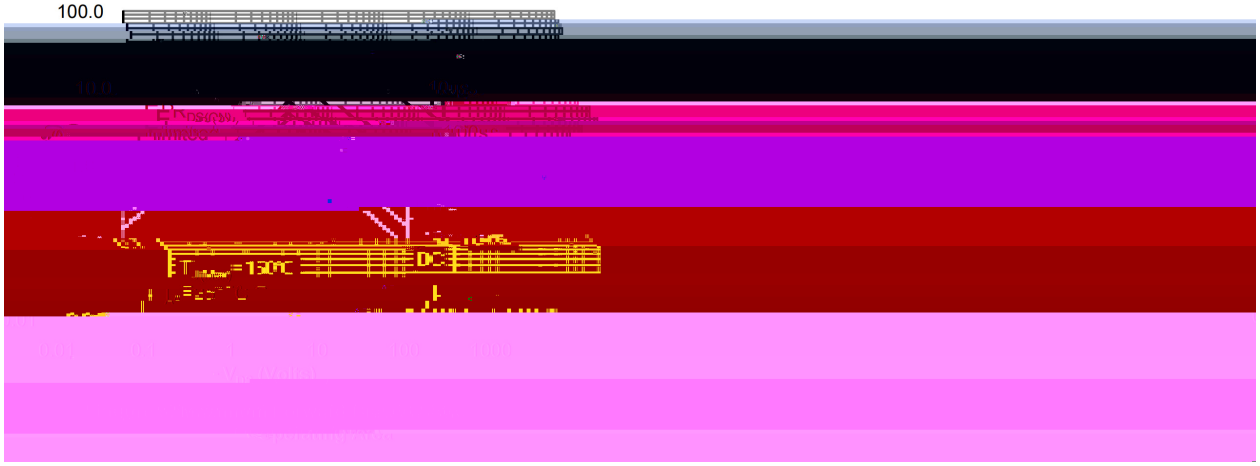




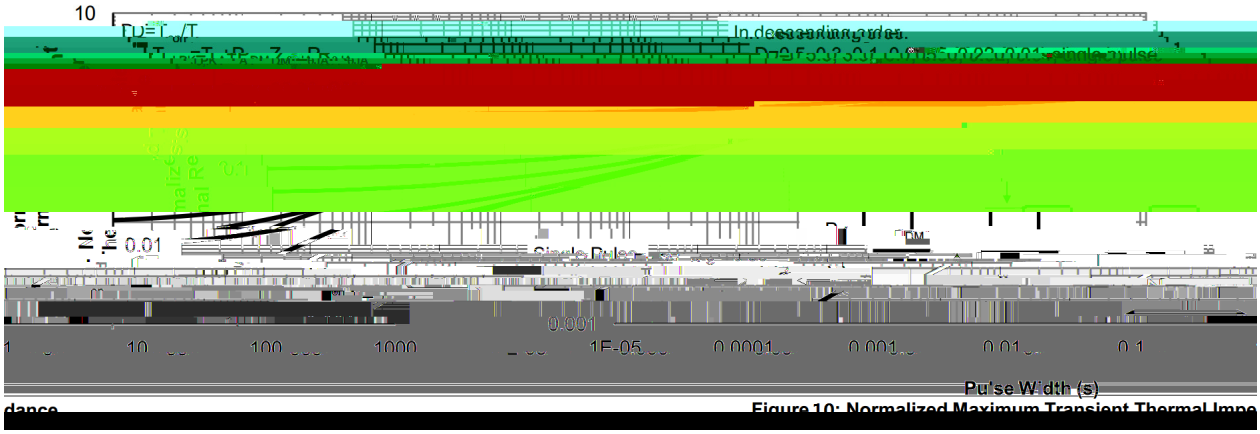
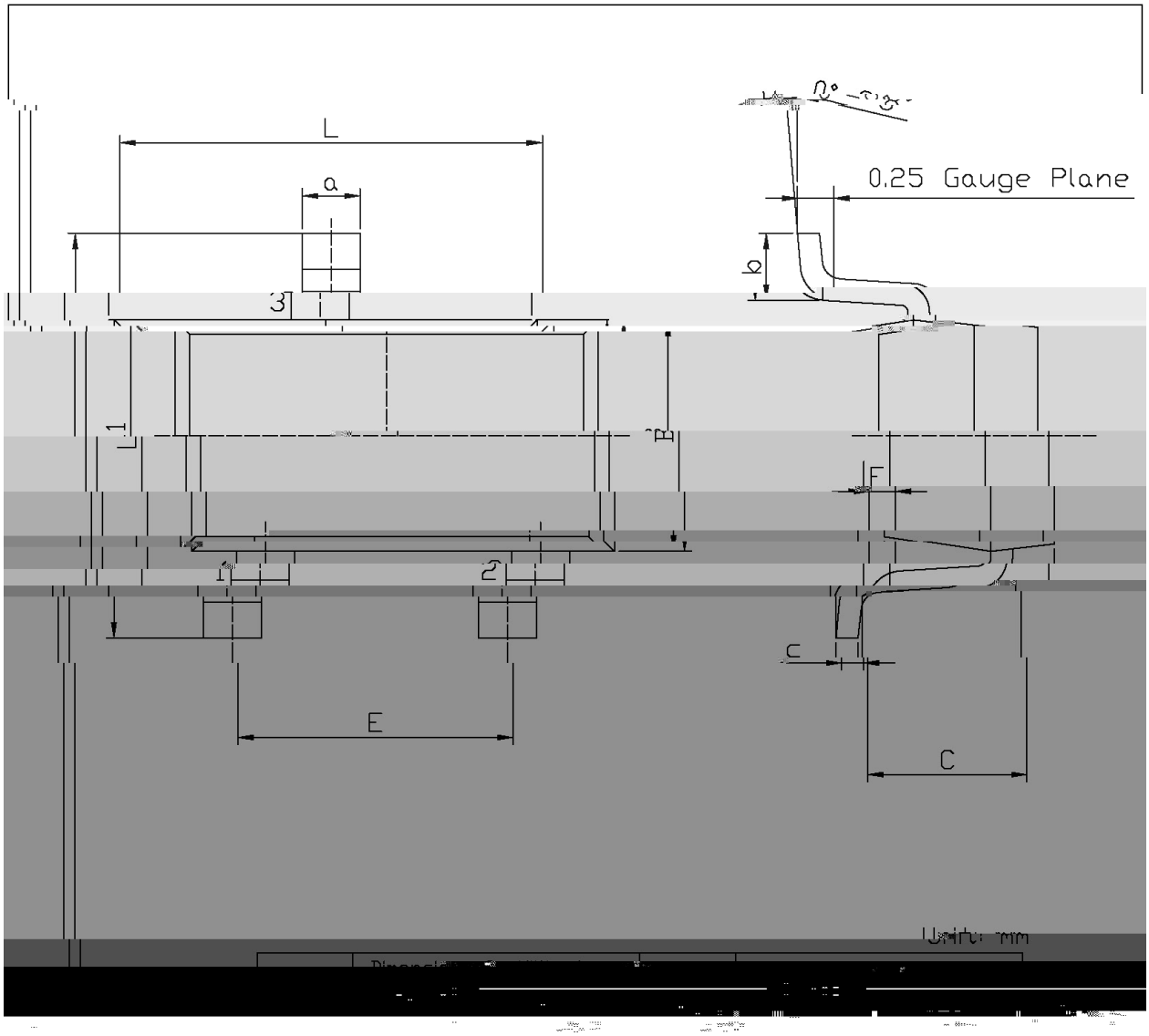


Figure 10: Normalized Maximum Transient Thermal Impe

/ Package Dimensions



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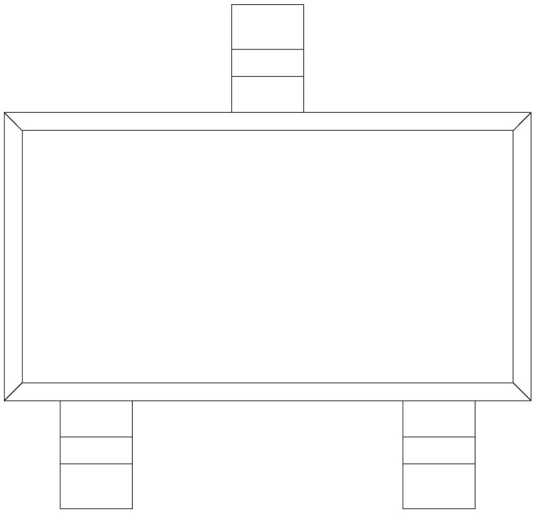

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)

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/ Resistance to Soldering Heat Test Conditions

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